

Thermal Performance

Parameter		Symbol	Limit	Unit
Thermal Resistance - Junction to Case	TO-220	$R_{\theta_{JC}}$	1.0	$^{\circ}\text{C/W}$
	ITO-220		4.2	
Thermal Resistance - Junction to Ambient		$R_{\theta_{JA}}$	62.5	$^{\circ}\text{C/W}$

Note: Surface mounted on FR4 board $t \leq 10\text{sec}$

Electrical Specifications ($T_a = 25^{\circ}\text{C}$ unless otherwise noted)

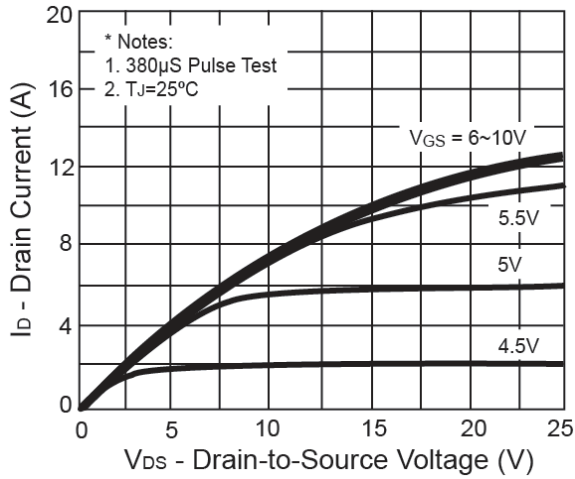
Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{GS} = 0\text{V}, I_D = 250\mu\text{A}$	BV_{DSS}	650	--	--	V
Drain-Source On-State Resistance	$V_{GS} = 10\text{V}, I_D = 3\text{A}$	$R_{DS(ON)}$	--	1.0	1.2	Ω
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	$V_{GS(TH)}$	2.0	--	4.0	V
Zero Gate Voltage Drain Current	$V_{DS} = 650\text{V}, V_{GS} = 0\text{V}$	I_{DSS}	--	--	1	μA
	$V_{DS} = 650\text{V}, V_{GS} = 0\text{V}, T_C = 125^{\circ}\text{C}$		--	--	50	
Gate Body Leakage	$V_{GS} = \pm 20\text{V}, V_{DS} = 0\text{V}$	I_{GSS}	--	--	± 10	μA
Forward Transfer Conductance	$V_{DS} = 8\text{V}, I_D = 1\text{A}$	g_{fs}	--	3.7	--	S
Diode Forward Voltage	$I_S = 6\text{A}, V_{GS} = 0\text{V}$	V_{SD}	--	--	1.6	V
Dynamic						
Total Gate Charge	$V_{DS} = 300\text{V}, I_D = 6\text{A}, V_{GS} = 10\text{V}$	Q_g	--	32	46	nC
Gate-Source Charge		Q_{gs}	--	6	--	
Gate-Drain Charge		Q_{gd}	--	11	--	
Input Capacitance	$V_{DS} = 25\text{V}, V_{GS} = 0\text{V}, f = 1.0\text{MHz}$	C_{iss}	--	905	--	pF
Output Capacitance		C_{oss}	--	115	--	
Reverse Transfer Capacitance		C_{rss}	--	25	--	
Switching						
Turn-On Delay Time	$V_{GS} = 10\text{V}, I_D = 6\text{A}, V_{DD} = 300\text{V}, R_G = 25\Omega$	$t_{d(on)}$	--	14	--	nS
Turn-On Rise Time		t_r	--	14	--	
Turn-Off Delay Time		$t_{d(off)}$	--	47	--	
Turn-Off Fall Time		t_f	--	19	--	
Reverse Recovery Time	$V_{GS} = 0\text{V}, I_S = 6\text{A}, dI_F/dt = 100\text{A}/\mu\text{s}$	t_{rr}	--	638	--	nS
Reverse Recovery Charge		Q_{rr}	--	4.8	--	μC

Note:

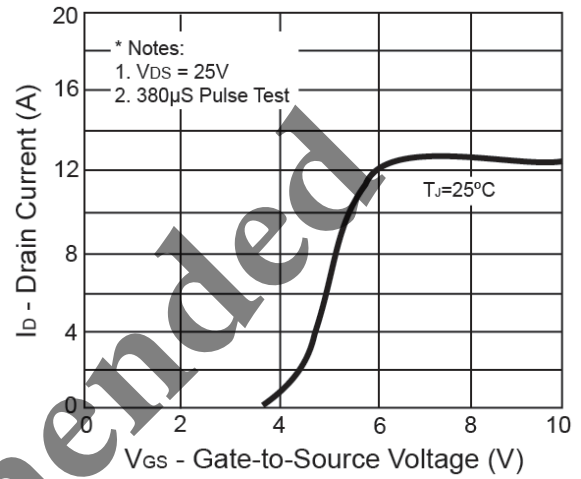
1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. $V_{DD} = 50\text{V}, I_{AS} = 3.6\text{A}, L = 30\text{mH}, V_{DS} = 500\text{V}$
3. Pulse test: pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
4. Essentially Independent of Operating Temperature

Electrical Characteristics Curve (Ta = 25°C, unless otherwise noted)

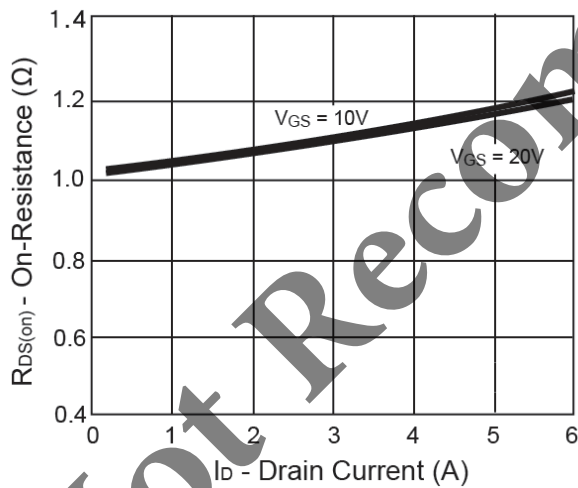
Output Characteristics



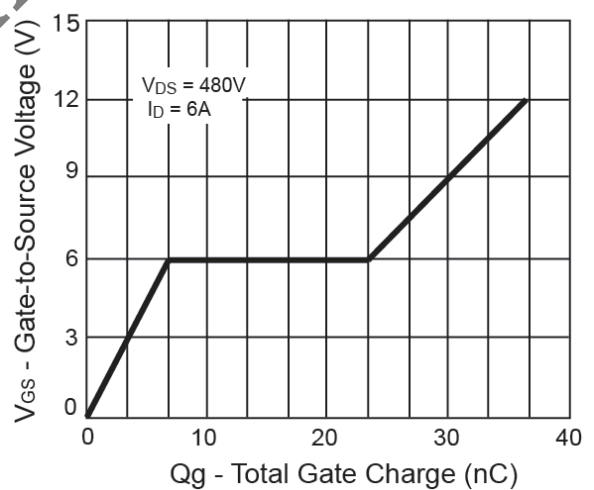
Transfer Characteristics



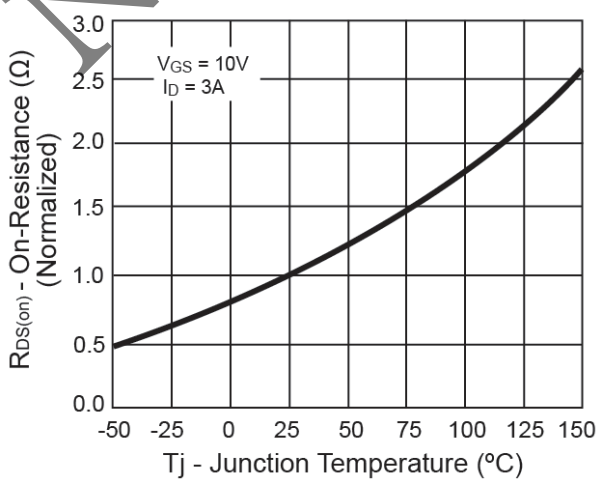
On-Resistance vs. Drain Current



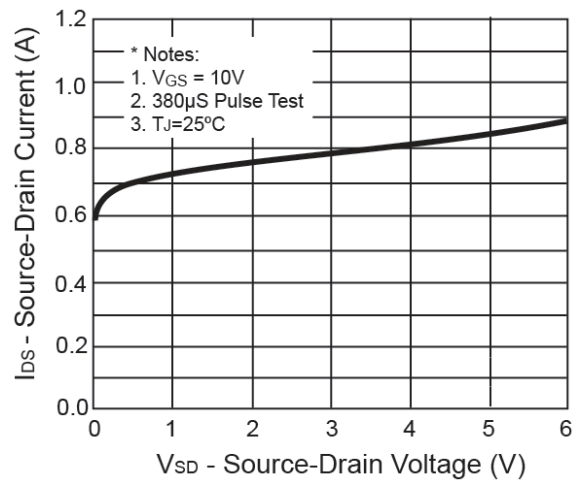
Gate Charge



On-Resistance vs. Junction Temperature

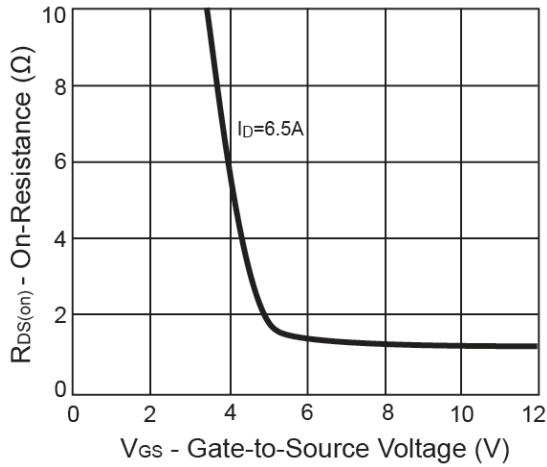


Source-Drain Diode Forward Voltage

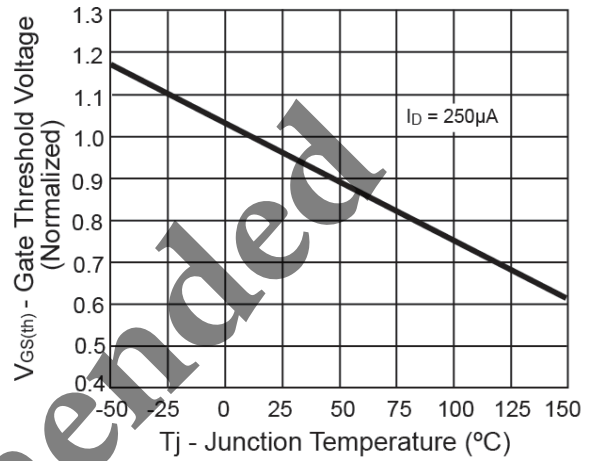


Electrical Characteristics Curve ($T_a = 25^\circ\text{C}$, unless otherwise noted)

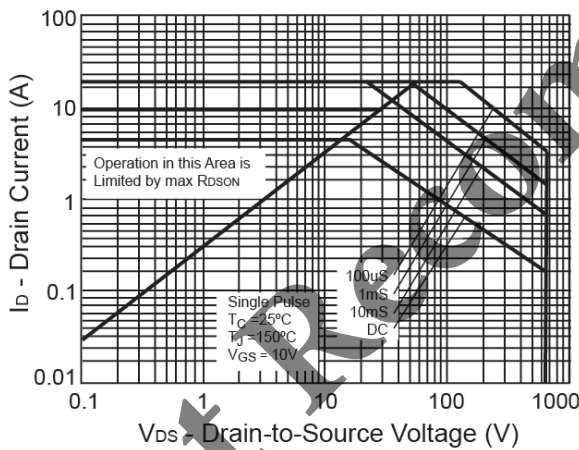
On-Resistance vs. Gate-Source Voltage



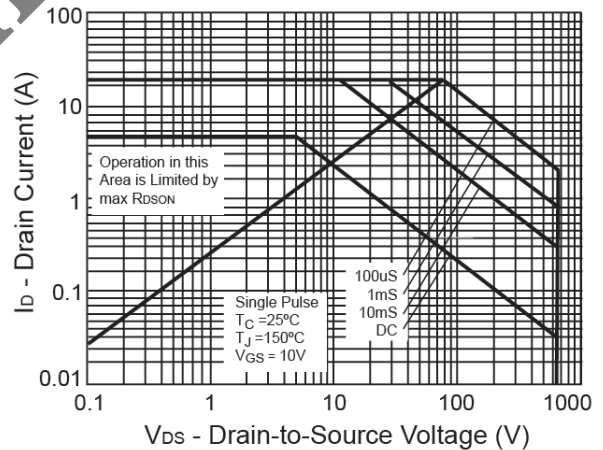
Threshold Voltage



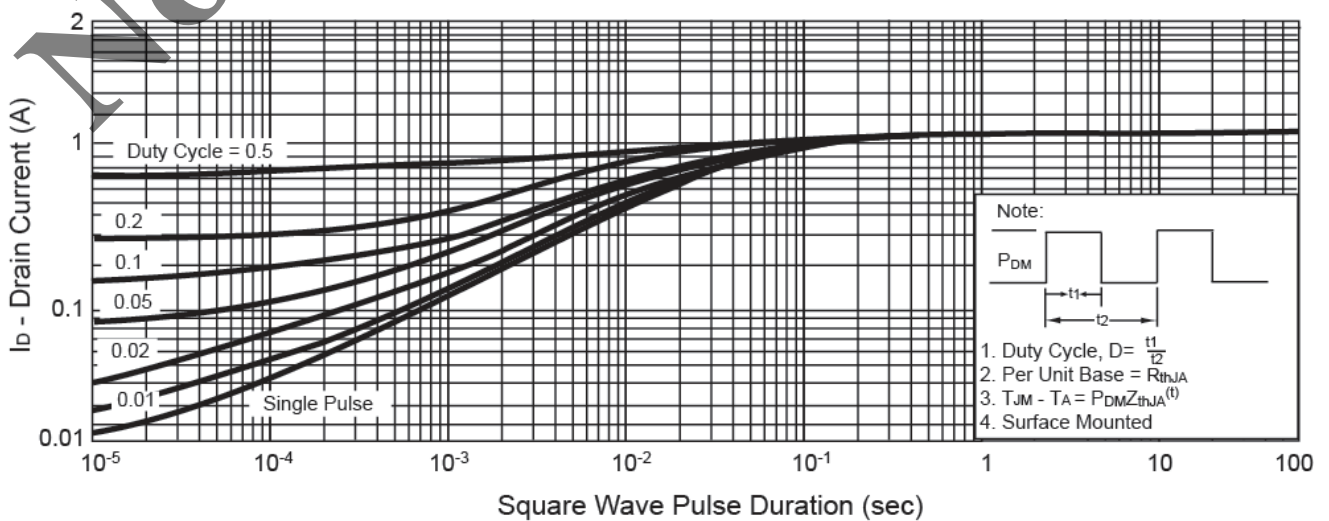
Maximum Safe Operating Area - TO-220



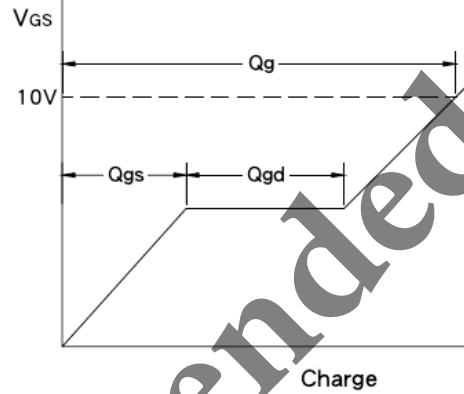
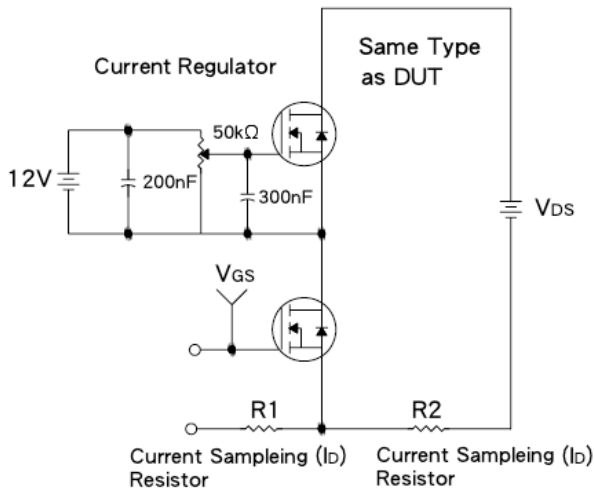
Maximum Safe Operating Area - ITO-220



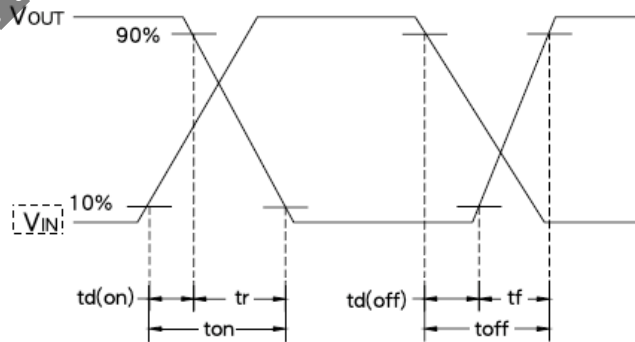
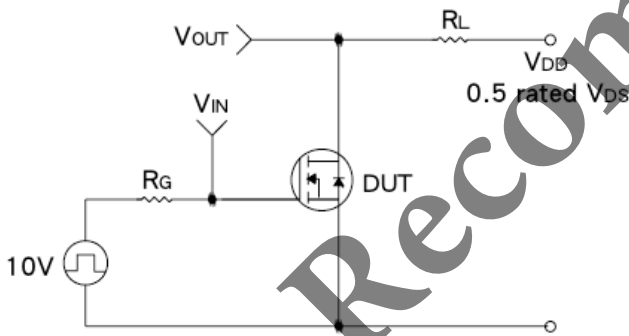
Normalized Thermal Transient Impedance, Junction-to-Ambient



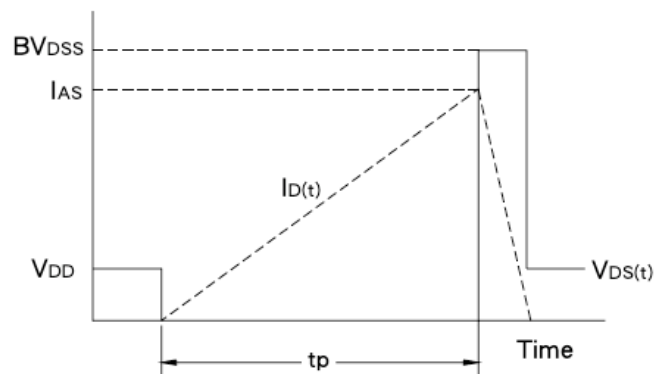
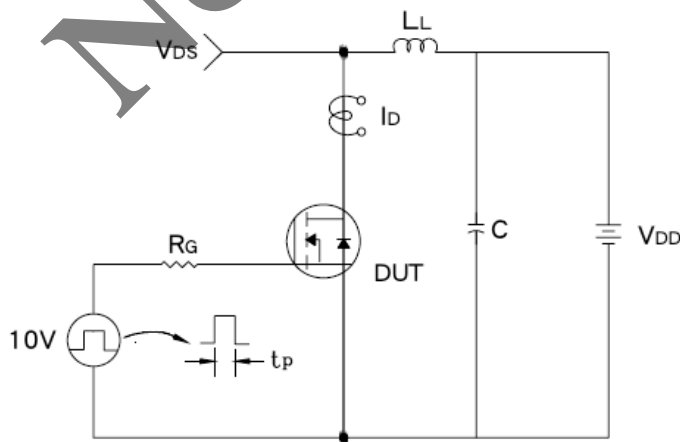
Gate Charge Test Circuit & Waveform



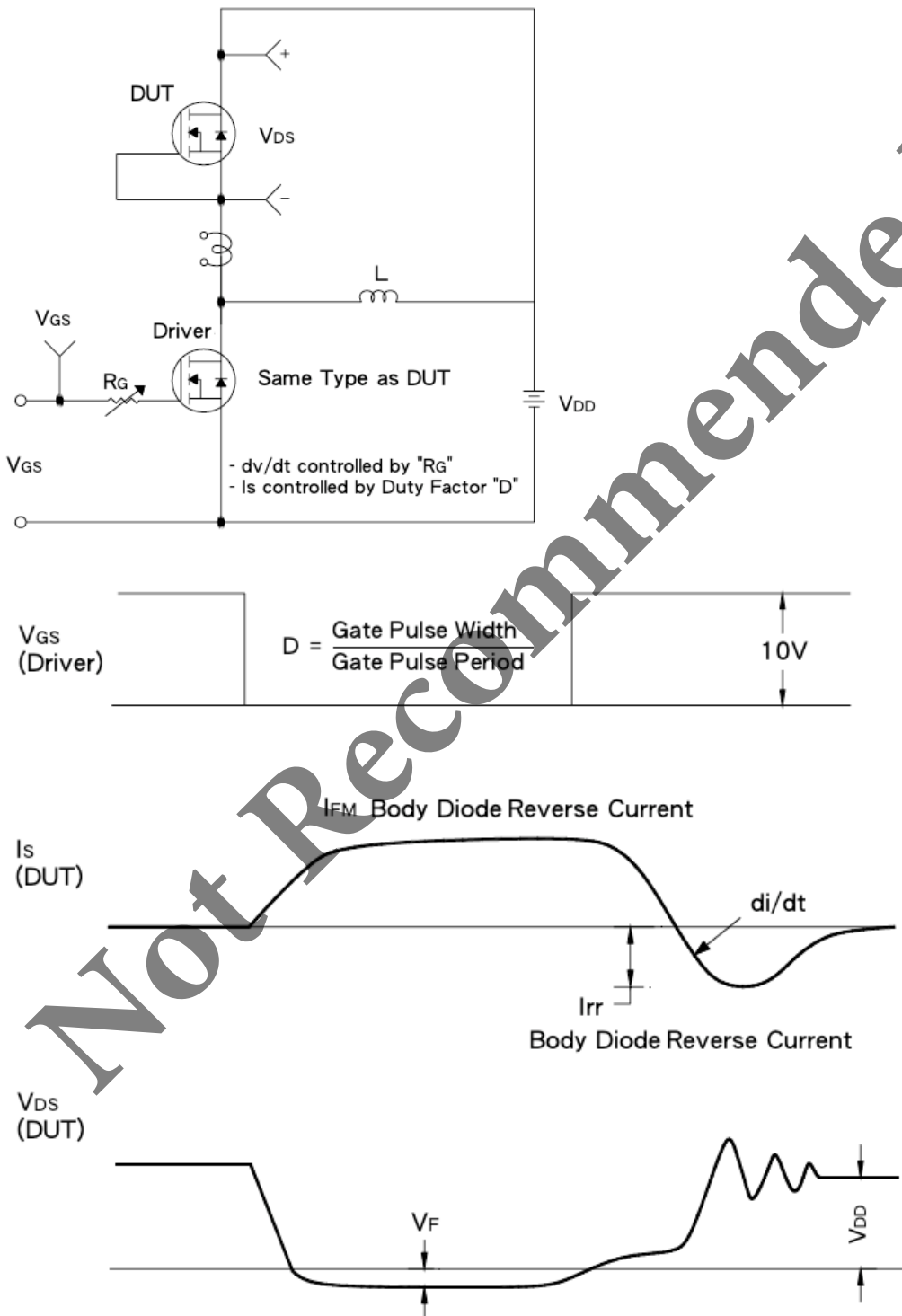
Resistive Switching Test Circuit & Waveform



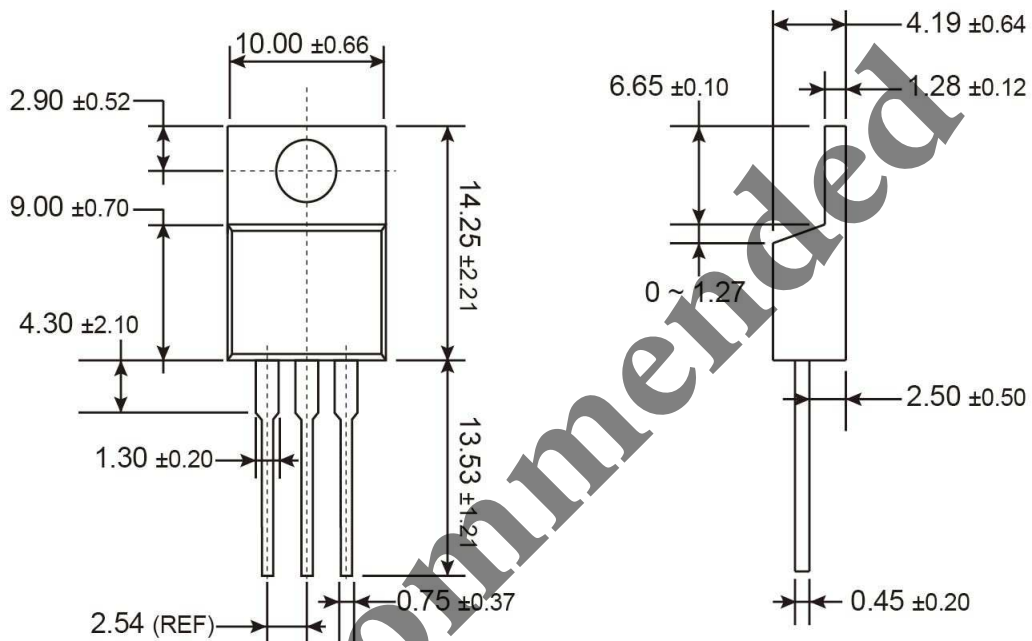
E_{AS} Test Circuit & Waveform



Diode Reverse Recovery Time Test Circuit & Waveform

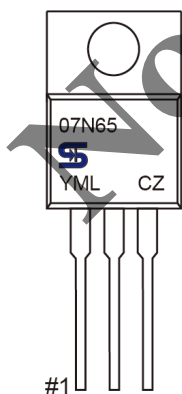


TO-220 Mechanical Drawing



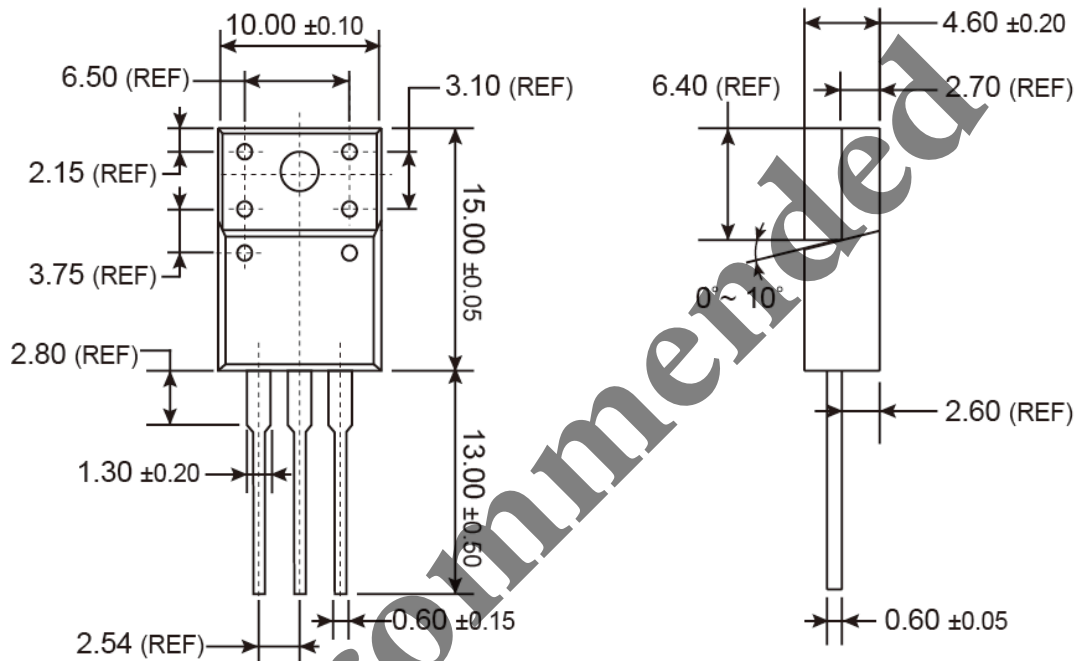
Unit: Millimeters

Marking Diagram



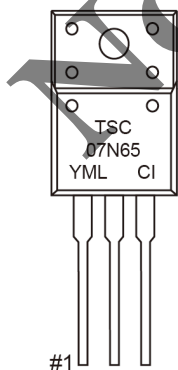
- Y** = Year Code
- M** = Month Code
(**A**=Jan, **B**=Feb, **C**=Mar, **D**=Apr, **E**=May, **F**=Jun, **G**=Jul, **H**=Aug, **I**=Sep, **J**=Oct, **K**=Nov, **L**=Dec)
- L** = Lot Code

ITO-220 Mechanical Drawing



Unit: Millimeters

Marking Diagram



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Not Recommended

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